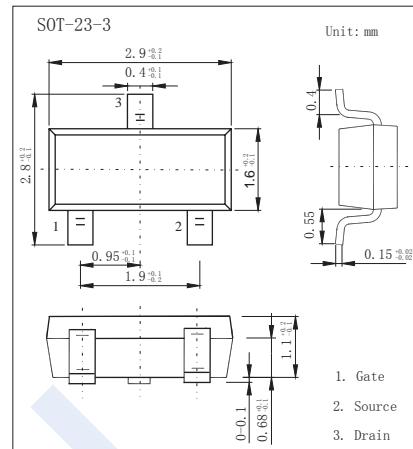
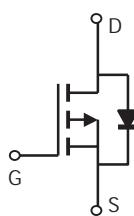


## P-Channel Enhancement MOSFET

2KJ6012

## ■ Features

- $V_{DS}(V) = -30V$
- $I_D = -4.1 A$
- $R_{DS(ON)} < 52m\Omega$  ( $V_{GS} = -10V$ )
- $R_{DS(ON)} < 87m\Omega$  ( $V_{GS} = -4.5V$ )

■ Absolute Maximum Ratings  $T_a = 25^\circ C$ 

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current $T_a = 25^\circ C$	$I_D$	-4.1	A
$T_a = 70^\circ C$		-3.5	
Pulsed Drain Current	$I_{DM}$	-20	
Power Dissipation $T_a = 25^\circ C$	$P_D$	1.4	W
$T_a = 70^\circ C$		1	
Thermal Resistance.Junction- to-Ambient $t \leq 10s$	$R_{thJA}$	90	$^\circ C/W$
Steady State		125	
Thermal Resistance.Junction- to-Lead	$R_{thJL}$	60	
Junction Temperature	$T_J$	150	$^\circ C$
Storage Temperature Range	$T_{stg}$	-55 to 150	

## P-Channel Enhancement MOSFET

## 2KJ6012

■ Electrical Characteristics  $T_a = 25^\circ\text{C}$ 

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{DSS}$	$I_D = -250 \mu\text{A}, V_{GS} = 0\text{V}$	-30			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}$			-1	$\mu\text{A}$
		$V_{DS} = -24\text{V}, V_{GS} = 0\text{V}, T_J = 55^\circ\text{C}$			-5	
Gate-Body leakage current	$I_{GSS}$	$V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	-1	-1.4	-1.8	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = -10\text{V}, I_D = -4.1\text{A}$			52	$\text{m}\Omega$
		$V_{GS} = -10\text{V}, I_D = -4\text{A}, T_J = 125^\circ\text{C}$			73	
		$V_{GS} = -4.5\text{V}, I_D = -3\text{A}$			87	
On state drain current	$I_{D(\text{ON})}$	$V_{GS} = -4.5\text{V}, V_{DS} = -5\text{V}$	-10			A
Forward Transconductance	$g_{FS}$	$V_{DS} = -5\text{V}, I_D = -4\text{A}$	5.5	8.2		S
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = -15\text{V}, f = 1\text{MHz}$		700		$\text{pF}$
Output Capacitance	$C_{oss}$			120		
Reverse Transfer Capacitance	$C_{rss}$			75		
Gate resistance	$R_g$	$V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$		10		$\Omega$
Total Gate Charge	$Q_g$	$V_{GS} = -4.5\text{V}, V_{DS} = -15\text{V}, I_D = -4\text{A}$		14.3		$\text{nC}$
Gate Source Charge	$Q_{gs}$			7		
Gate Drain Charge	$Q_{gd}$			3.1		
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = -10\text{V}, V_{DS} = -15\text{V}, R_L = 3.6 \Omega, R_{GEN} = 3 \Omega$		8.6		$\text{ns}$
Turn-On Rise Time	$t_r$			5		
Turn-Off Delay Time	$t_{d(off)}$			28.2		
Turn-Off Fall Time	$t_f$			13.5		
Body Diode Reverse Recovery Time	$t_{rr}$			27		
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = -4\text{A}, dI/dt = 100\text{A}/\mu\text{s}$		15		$\text{nC}$
Maximum Body-Diode Continuous Current	$I_S$				-2.2	
Diode Forward Voltage	$V_{SD}$	$I_S = -1\text{A}, V_{GS} = 0\text{V}$		-0.77	-1	V

## ■ Marking

Marking	JAD
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## P-Channel Enhancement MOSFET

**2KJ6012**

### ■ Typical Characteristics

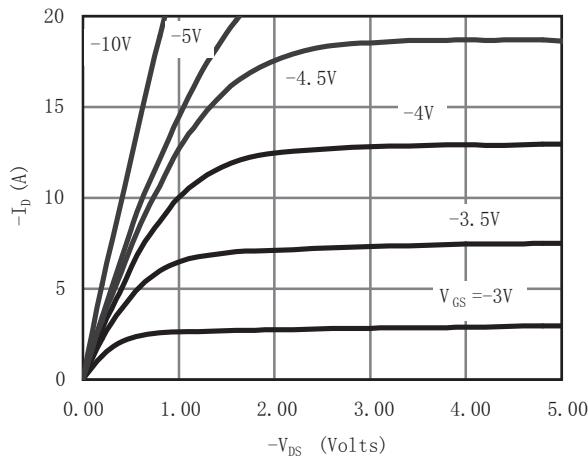


Figure 1: On-Region Characteristics

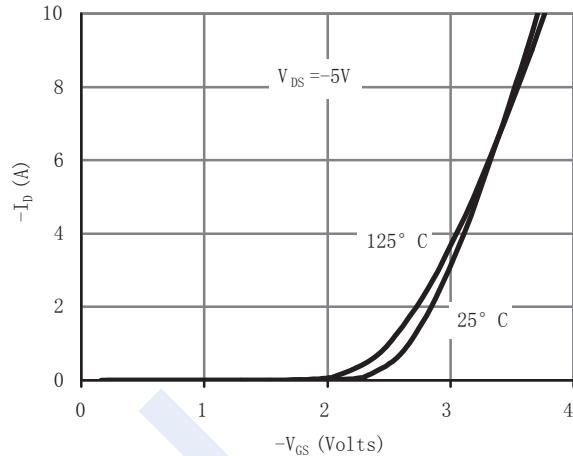


Figure 2: Transfer Characteristics

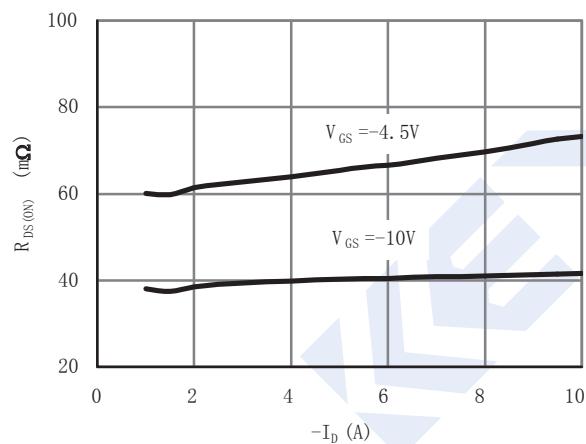


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

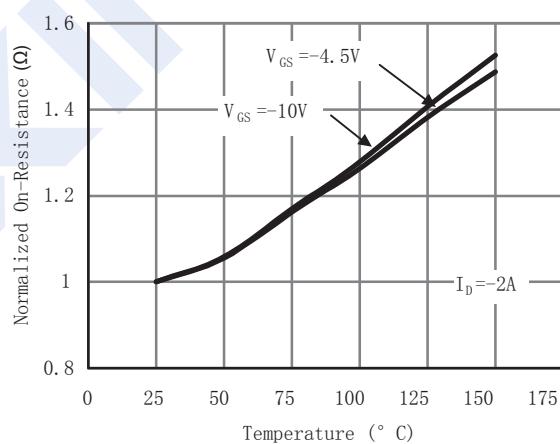


Figure 4: On-Resistance vs. Junction Temperature

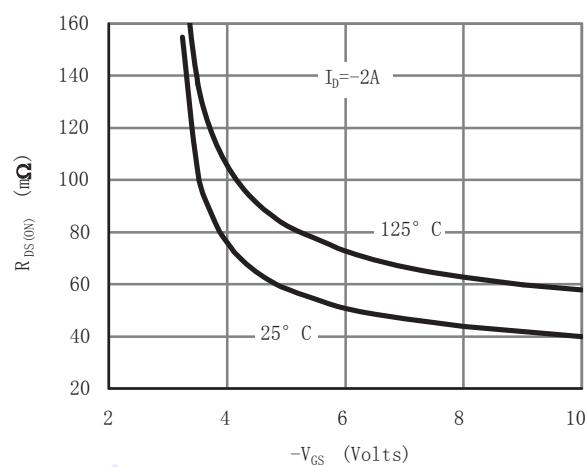


Figure 5: On-Resistance vs. Gate-Source Voltage

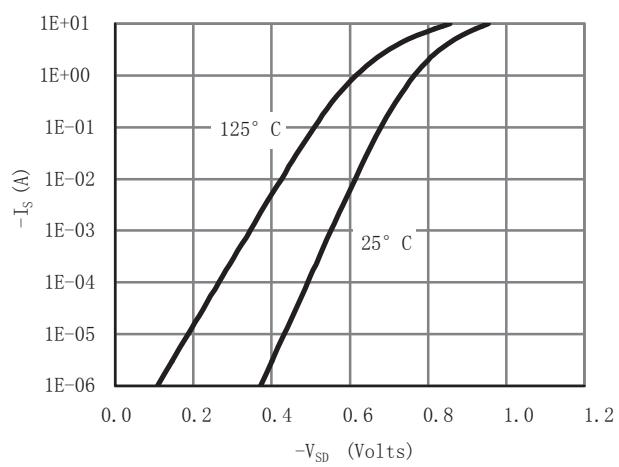


Figure 6: Body-Diode Characteristics

## P-Channel Enhancement MOSFET

### 2KJ6012

#### ■ Typical Characteristics

